



Low power consumption, Low ESR Cap.Compatible ME6206 Series

General Description

ME6206 series are highly precise, low power consumption, high voltage, positive voltage regulators manufactured using CMOS and laser trimming technologies .The series provides large currents with a significantly small dropout voltage. The series is compatible with low ESR ceramic capacitors .The current limiter's foldback circuit also operates as a short protect for the output current limiter and the output pin.

Features

- Maximum Output Current: 300mA ($V_{IN}=4.3V, V_{OUT}=3.3V$)
- Dropout Voltage: 200mV@ $I_{OUT} = 100mA$
- Input Voltage Range: up to 6.0V
- Highly Accuracy: $\pm 2\%$
- Low Power Consumption: 8uA (TYP.)
- Excellent Input Stability
- Be available to regulator and reference voltage

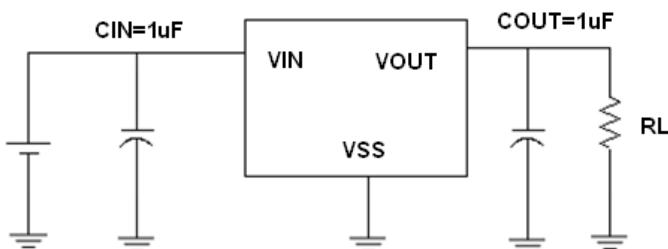
Typical Application

- Mobile phones
- communication equipment
- Portable games
- Cameras, Video systems
- Reference voltage sources
- Battery powered equipment

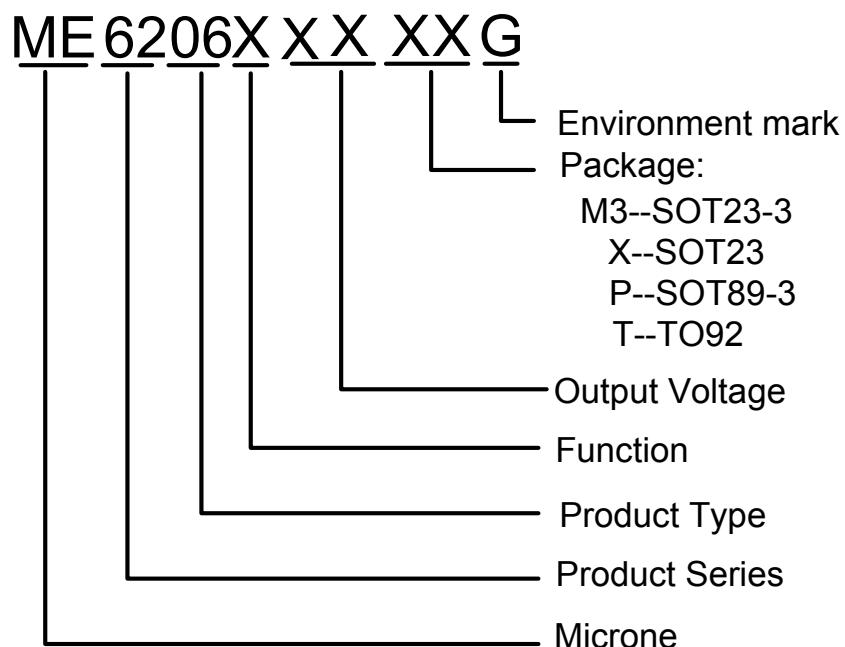
Package

- 3-pin SOT89-3, SOT23-3, TO92, SOT23

Typical Application Circuit



Selection Guide



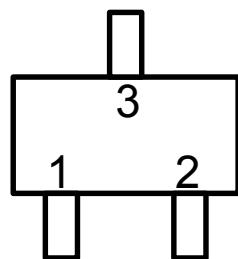
product series	Output voltage	Supply Current	Package
ME6206A15PG	1.5V	8uA	SOT89-3
ME6206A15M3G	1.5V	8uA	SOT23-3
ME6206A15XG	1.5V	8uA	SOT23
ME6206A33TG	3.3V	8uA	TO92
ME6206A33M3G	3.3V	8uA	SOT23-3
ME6206K33M3G	3.3V	180uA	SOT23-3

NOTE: At present ,there are ten kinds of voltage value:

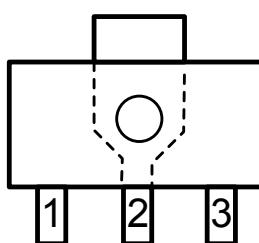
1.5V、1.8V、2.0V、2.1V、2.5V、2.7V、2.8V、3.0V、3.3V、3.6V。

If you need other voltage and package, please contact our sales staff.

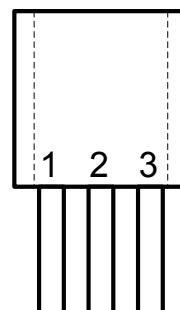
Pin Configuration



SOT23/SOT23-3



SOT89-3



TO92

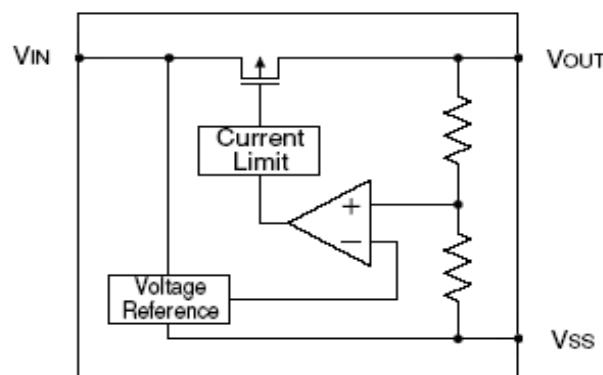
Pin Assignment

ME6206Axx/ ME6206Kxx

Pin					Name	Function
M3	P	P1	X	T		
SOT23-3	SOT89-3	SOT89-3	SOT23	TO-92		
1	1	2	1	1	VSS	Ground
2	3	1	2	3	VOUT	Output
3	2	3	3	2	VIN	Input

The difference of printing on the chip between P and P1 is : P: 6206A , P1: 6206A1

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Description	Units
Input Voltage	V _{IN}	6.5	V
Output Current	I _{out}	500	mA
Output Voltage	V _{out}	V _{ss} -0.3 ~ V _{out} +0.3	V
Power Dissipation	SOT23-3	Pd	300
	SOT89-3	Pd	500
	SOT23	Pd	300
	TO-92	Pd	500
Operating Ambient Temperature	T _{Opr}	-25 ~ +125	°C
Storage Temperature	T _{stg}	-40 ~ +125	°C

ME6206A15

(V_{IN}=V_{out}+1V, C_{in}=C_{out}=1uF, T_a=25°C Unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIX	TYP	MAX	UNIT
Output Voltage	V _{OUT(E)} (Note 2)	I _{OUT} =10mA, V _{IN} =V _{out} +1V	X 0.98	V _{OUT(T)} (Note 1)	X 1.02	V
Input Voltage	V _{IN}				6	V
Maximum Output Current	I _{OUT} (max)	V _{IN} =V _{out} +1V		100		mA
Load Regulation	ΔV _{OUT}	V _{IN} =V _{out} +1V, 1mA≤I _{OUT} ≤80mA		10	20	mV
Dropout Voltage (Note 3)	V _{dif1}	I _{OUT} =20mA		180	200	mV
	V _{dif2}	I _{OUT} =50mA		360	380	mV
Supply Current	I _{SS}	V _{IN} =V _{out} +1V		7	15	μA
Line Regulations	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot V_{OUT}}$	I _{OUT} =10mA V _{out} +1V ≤V _{IN} ≤5V		0.1	0.2	%/V
Power Supply Ripple Rejection Ratio	PSRR	V _{in} = [V _{out} +1]V +1Vp-pAC I _{OUT} =10mA, f=1kHz		45	47	dB
Short Circuit Current	I _{short}	V _{in} =V _{out(T)} +1.5V V _{out} =V _{ss}		20	50	mA
Over Current Protection	I _{limit}			300		mA

ME6206A18

(VIN=Vout+1V,Cin=Cout=1uF,Ta=25°C Unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIX	TYP	MAX	UNIT
Output Voltage	V _{OUT} (E) (Note 2)	I _{OUT} =10mA, V _{IN} =Vout+1V	X 0.98	V _{OUT} (T) (Note 1)	X 1.02	V
Input Voltage	V _{IN}				6	V
Maximum Output Current	I _{OUT} (max)	V _{IN} =Vout+1V		120		mA
Load Regulation	ΔV _{OUT}	V _{IN} =Vout+1V, 1mA≤I _{OUT} ≤80mA		12	27	mV
Dropout Voltage (Note 3)	V _{dif1}	I _{OUT} =20mA		180	200	mV
	V _{dif2}	I _{OUT} =50mA		360	380	mV
Supply Current	I _{SS}	V _{IN} =Vout+1V		7	15	μA
Line Regulations	ΔV _{OUT} ΔV _{IN} • V _{OUT}	I _{OUT} =10mA Vout+1V ≤ V _{IN} ≤ 5V		0.1	0.2	%/V
Power Supply Ripple Rejection Ratio	PSRR	Vin=[Vout+1]V +1Vp-pAC I _{OUT} =10mA,f=1kHz		45	47	dB
Short Circuit Current	I _{short}	Vin=Vout(T)+1.5V Vout=Vss		25	50	mA
Over Current Protection	I _{limit}			400		mA

ME6206A21

(VIN=Vout+1V,Cin=Cout=1uF,Ta=25°C Unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIX	TYP	MAX	UNIT
Output Voltage	V _{OUT} (E) (Note 2)	I _{OUT} =10mA, V _{IN} =Vout+1V	X 0.98	V _{OUT} (T) (Note 1)	X 1.02	V
Input Voltage	V _{IN}				6	V
Maximum Output Current	I _{OUT} (max)	V _{IN} =Vout+1V		200		mA
Load Regulation	ΔV _{OUT}	V _{IN} =Vout+1V, 1mA≤I _{OUT} ≤80mA		10	20	mV
Dropout Voltage (Note 3)	V _{dif1}	I _{OUT} =50mA		100	130	mV
	V _{dif2}	I _{OUT} =100mA		200	230	mV
Supply Current	I _{SS}	V _{IN} =Vout+1V		7	15	μA
Line Regulations	ΔV _{OUT} ΔV _{IN} • V _{OUT}	I _{OUT} =10mA Vout+1V ≤ V _{IN} ≤ 5V		0.1	0.2	%/V
Power Supply Ripple Rejection Ratio	PSRR	Vin=[Vout+1]V +1Vp-pAC I _{OUT} =10mA,f=1kHz		45	47	dB
Short Circuit Current	I _{short}	Vin=Vout(T)+1.5V Vout=Vss		20	50	mA
Over Current Protection	I _{limit}			450		mA

ME6206A28

(VIN=Vout+1V,Cin=Cout=1uF,Ta=25°C Unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIX	TYP	MAX	UNIT
Output Voltage	V _{OUT} (E) (Note 2)	I _{OUT} =10mA, V _{IN} =Vout+1V	X 0.98	V _{OUT} (T) (Note 1)	X 1.02	V
Input Voltage	V _{IN}				6	V
Maximum Output Current	I _{OUT} (max)	V _{IN} =Vout+1V		300		mA
Load Regulation	ΔV _{OUT}	V _{IN} =Vout+1V 1mA≤I _{OUT} ≤100mA		14	28	mV
Dropout Voltage (Note 3)	V _{dif1}	I _{OUT} =80mA		180	200	mV
	V _{dif2}	I _{OUT} =200mA		380	400	mV
Supply Current	I _{SS}	V _{IN} =Vout+1V		8	15	μA
Line Regulations	ΔV _{OUT} ΔV _{IN} • V _{OUT}	I _{OUT} =10mA Vout+1V ≤V _{IN} ≤6V		0.03	0.2	%/V
Power Supply Ripple Rejection Ratio	PSRR	Vin= [Vout+1]V +1Vp-pAC I _{OUT} =10mA,f=1kHz		50	52	dB
Short Circuit Current	I _{short}	Vin=Vout(T)+1.5V Vout=Vss		30	60	mA
Over Current Protection	I _{limit}			500		mA

ME6206A30

(VIN=Vout+1V,Cin=Cout=1uF,Ta=25°C Unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIX	TYP	MAX	UNIT
Output Voltage	V _{OUT} (E) (Note 2)	I _{OUT} =10mA, V _{IN} =Vout+1V	X 0.98	V _{OUT} (T) (Note 1)	X 1.02	V
Input Voltage	V _{IN}				6	V
Maximum Output Current	I _{OUT} (max)	V _{IN} =Vout+1V		300		mA
Load Regulation	ΔV _{OUT}	V _{IN} =Vout+1V 1mA≤I _{OUT} ≤100mA		14	28	mV
Dropout Voltage (Note 3)	V _{dif1}	I _{OUT} =80mA		180		mV
	V _{dif2}	I _{OUT} =200mA		380		mV
Supply Current	I _{SS}	V _{IN} =Vout+1V		8	15	μA
Line Regulations	ΔV _{OUT} ΔV _{IN} • V _{OUT}	I _{OUT} =10mA Vout+1V ≤V _{IN} ≤6V		0.03	0.2	%/V
Power Supply Ripple Rejection Ratio	PSRR	Vin= [Vout+1]V +1Vp-pAC I _{OUT} =10mA,f=1kHz		50	52	dB
Short Circuit Current	I _{short}	Vin=Vout(T)+1.5V Vout=Vss		30	60	mA
Over Current Protection	I _{limit}			500		mA

ME6206A33

(VIN=Vout+1V,Cin=Cout=1uF,Ta=25°C Unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIX	TYP	MAX	UNIT
Output Voltage	V _{OUT(E)} (Note 2)	I _{OUT} =10mA, V _{IN} =Vout+1V	X 0.98	V _{OUT(T)} (Note 1)	X 1.02	V
Input Voltage	V _{IN}				6	V
Maximum Output Current	I _{OUT} (max)	V _{IN} =Vout+1V		300		mA
Load Regulation	ΔV _{OUT}	V _{IN} =Vout+1V 1mA≤I _{OUT} ≤100mA		14	28	mV
Dropout Voltage (Note 3)	V _{dif1}	I _{OUT} =80mA		180	200	mV
	V _{dif2}	I _{OUT} =200mA		380	400	mV
Supply Current	I _{SS}	V _{IN} =Vout+1V		9	15	μA
Line Regulations	ΔV _{OUT} ΔV _{IN} • V _{OUT}	I _{OUT} =10mA Vout+1V ≤ V _{IN} ≤ 6V		0.03	0.2	%/V
Power Supply Ripple Rejection Ratio	PSRR	V _{in} =[Vout+1]V +1Vp-pAC I _{OUT} =10mA,f=1kHz		50	52	dB
Short Circuit Current	I _{short}	V _{in} =Vout(T)+1.5V Vout=Vss		30	60	mA
Over Current Protection	I _{limit}			500		mA

ME6206K33

(VIN=Vout+1V,Cin=Cout=1uF,Ta=25°C Unless otherwise stated)

PARAMETER	SYMBOL	CONDITION	MIX	TYP	MAX	UNIT
Output Voltage	V _{OUT(E)} (Note 2)	I _{OUT} =10mA, V _{IN} =Vout+1V	X 0.98	V _{OUT(T)} (Note 1)	X 1.02	V
Input Voltage	V _{IN}				6	V
Maximum Output Current	I _{OUT} (max)	V _{IN} =Vout+1V		300		mA
Load Regulation	ΔV _{OUT}	V _{IN} =Vout+1V 1mA≤I _{OUT} ≤100mA		14	28	mV
Dropout Voltage (Note 3)	V _{dif1}	I _{OUT} =80mA		180	200	mV
	V _{dif2}	I _{OUT} =200mA		380	400	mV
Supply Current	I _{SS}	V _{IN} =Vout+1V		180	500	μA
Line Regulations	ΔV _{OUT} ΔV _{IN} • V _{OUT}	I _{OUT} =10mA Vout+1V ≤ V _{IN} ≤ 6V		0.03	0.2	%/V
Power Supply Ripple Rejection Ratio	PSRR	V _{in} =[Vout+1]V +1Vp-pAC I _{OUT} =10mA,f=1kHz		50	52	dB
Short Circuit Current	I _{short}	V _{in} =Vout(T)+1.5V Vout=Vss		30	60	mA
Over Current Protection	I _{limit}			500		mA

Note :

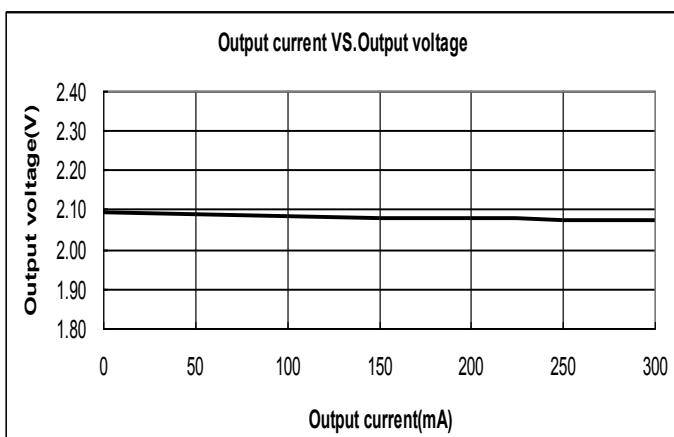
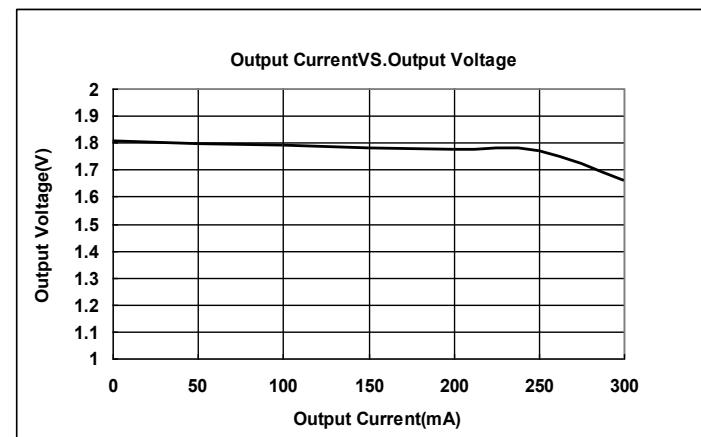
1. $V_{OUT}(T)$: Specified Output Voltage
2. $V_{OUT}(E)$: Effective Output Voltage (ie. The output voltage when " $V_{OUT}(T)+1.0V$ " is provided at the Vin pin while maintaining a certain I_{out} value.)
3. V_{dif} : $V_{IN1} - V_{OUT}(E)'$
 V_{IN1} : The input voltage when $V_{OUT}(E)'$ appears as input voltage is gradually decreased.
 $V_{OUT}(E)'$ = A voltage equal to 98% of the output voltage whenever an amply stabilized I_{out} ($V_{OUT}(T)+1.0V$) is input.

Type Characteristics

(1) Output Current VS. Output Voltage ($V_{IN}=V_{out}+1$, $T_a = 25^{\circ}\text{C}$)

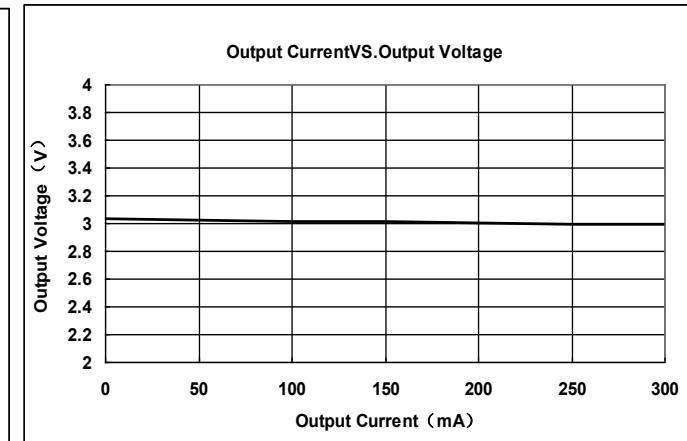
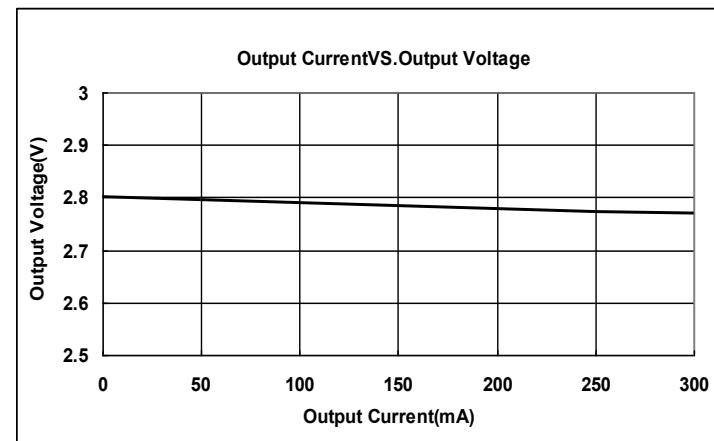
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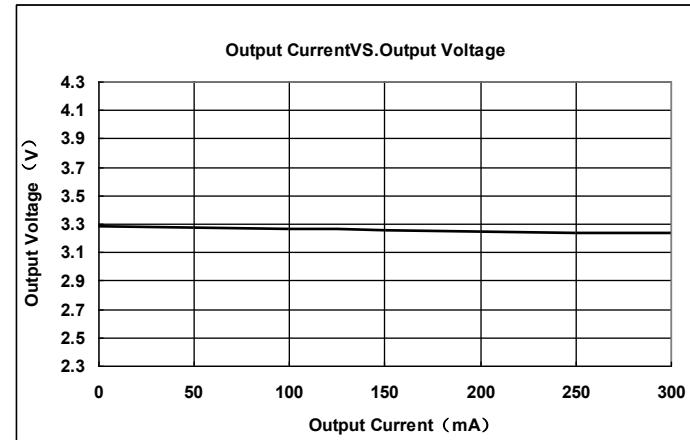


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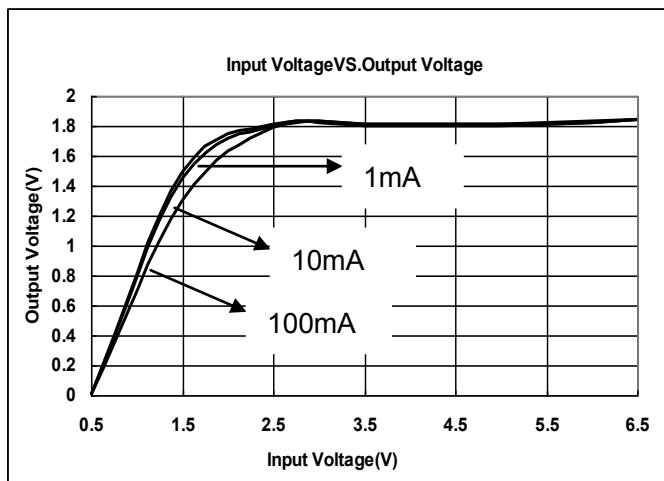


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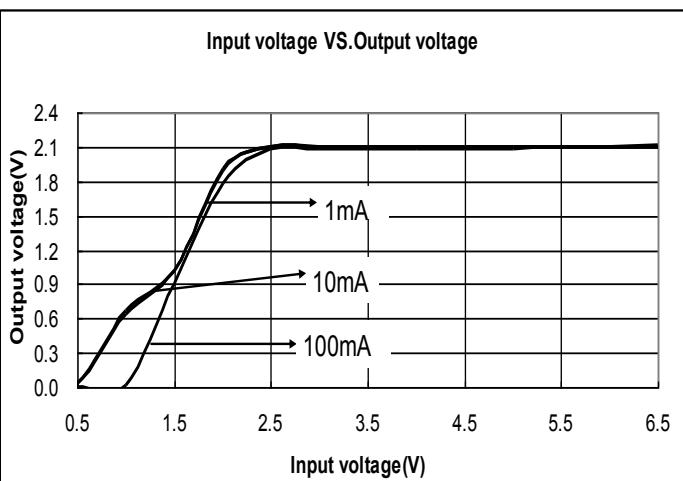


(2) Input Voltage VS. Output Voltage ($T_a = 25^{\circ}\text{C}$)

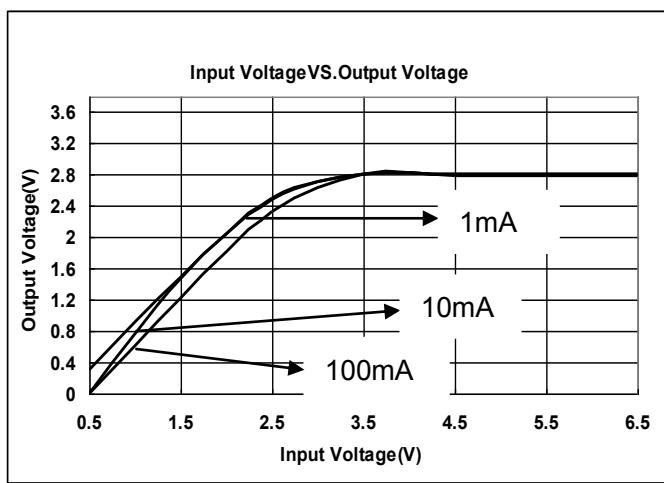
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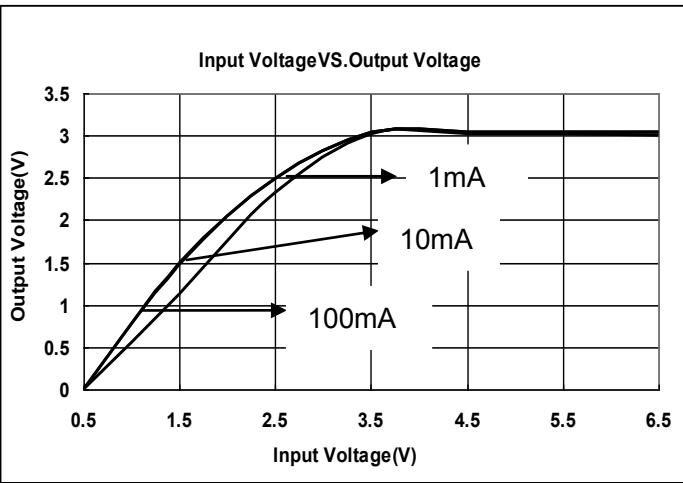
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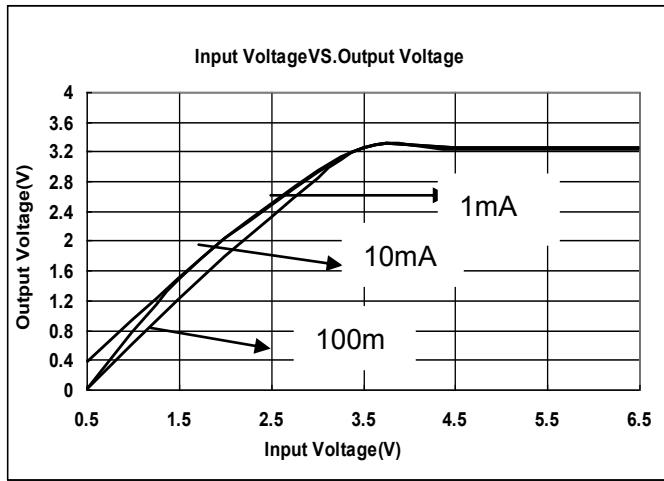
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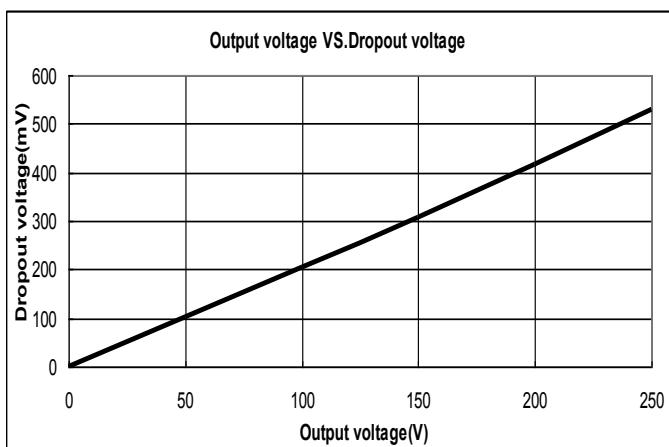
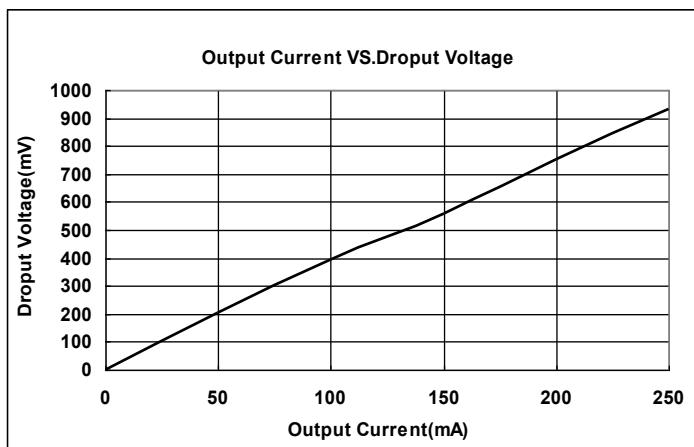
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(3) Output Current VS. Dropout Voltage ($V_{IN}=V_{out}+1V$, $T_a = 25^{\circ}\text{C}$)

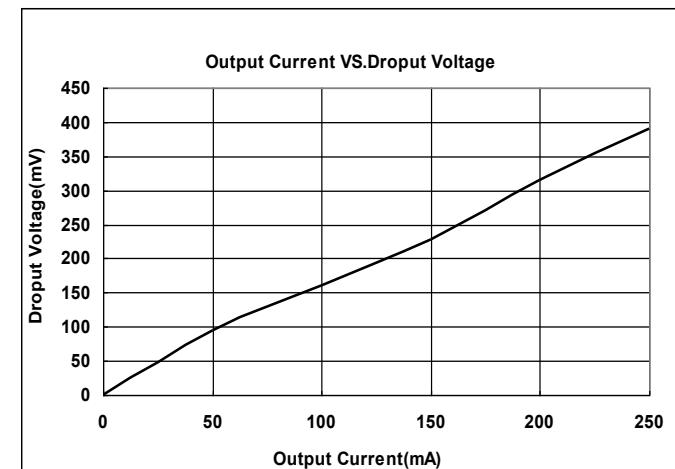
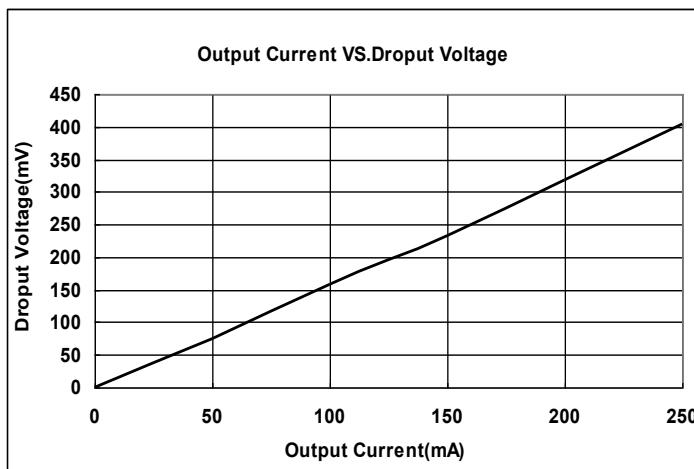
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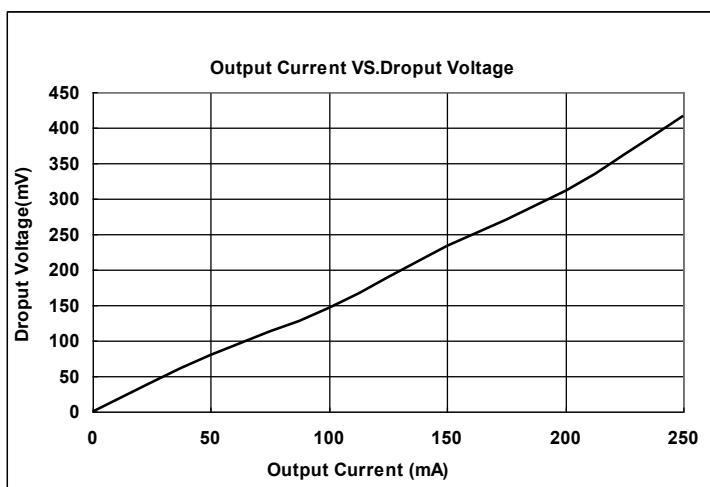


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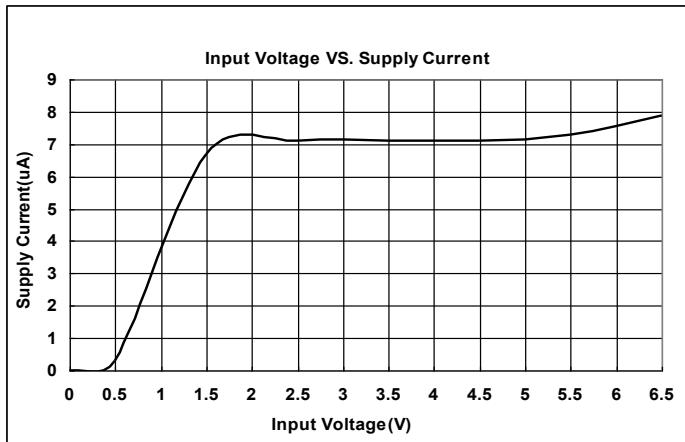


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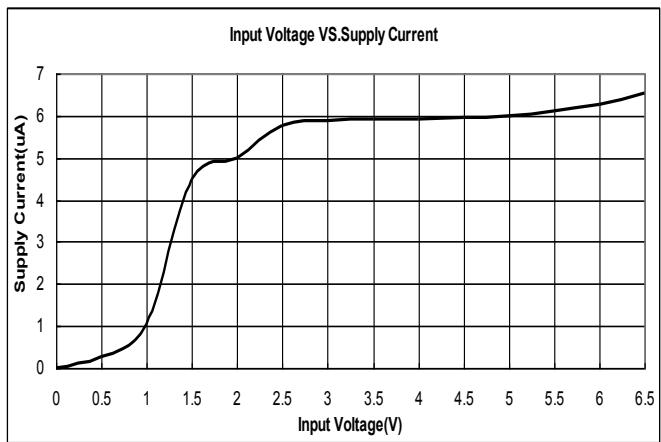


(4) Input Voltage VS. Supply Current (**T_a = 25 °C**)

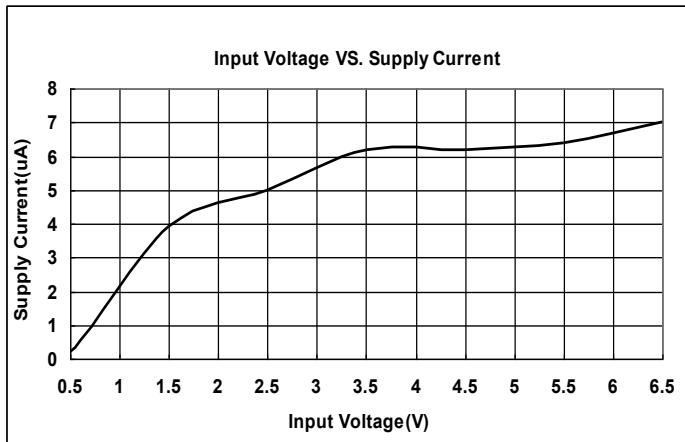
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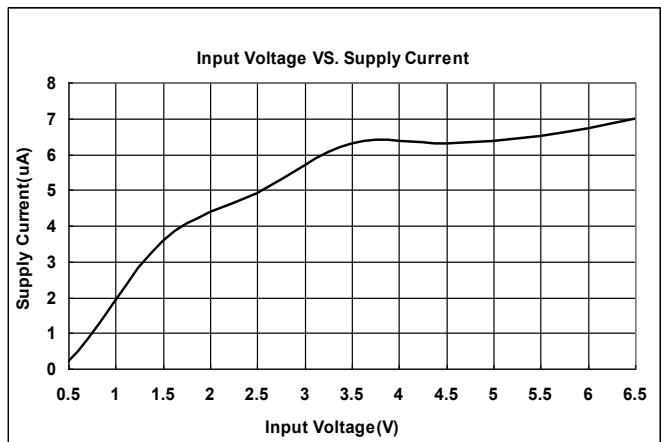
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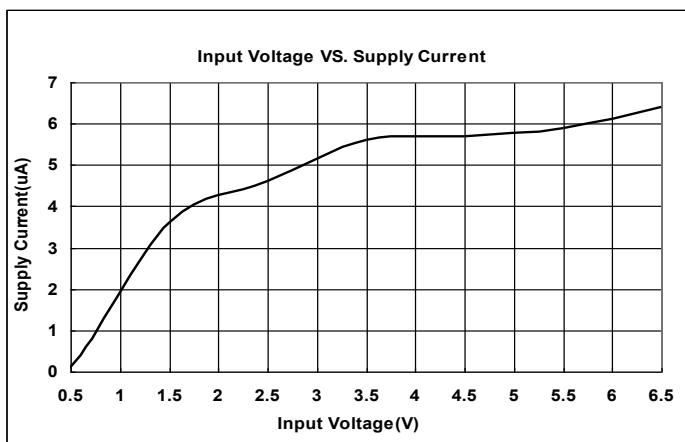
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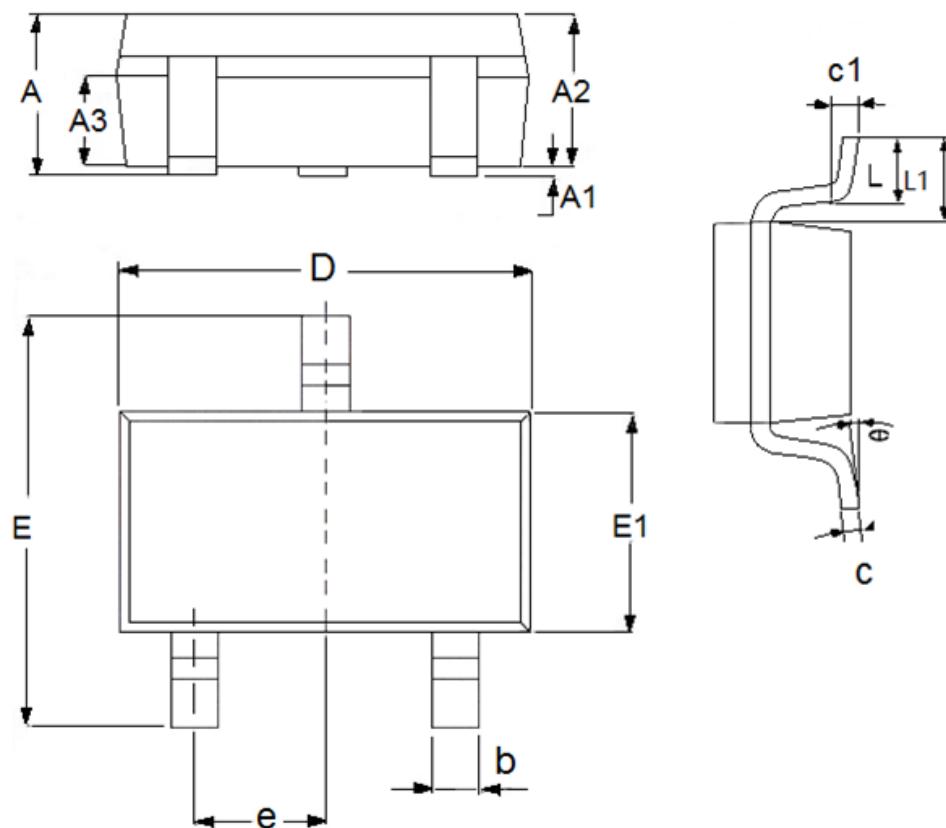


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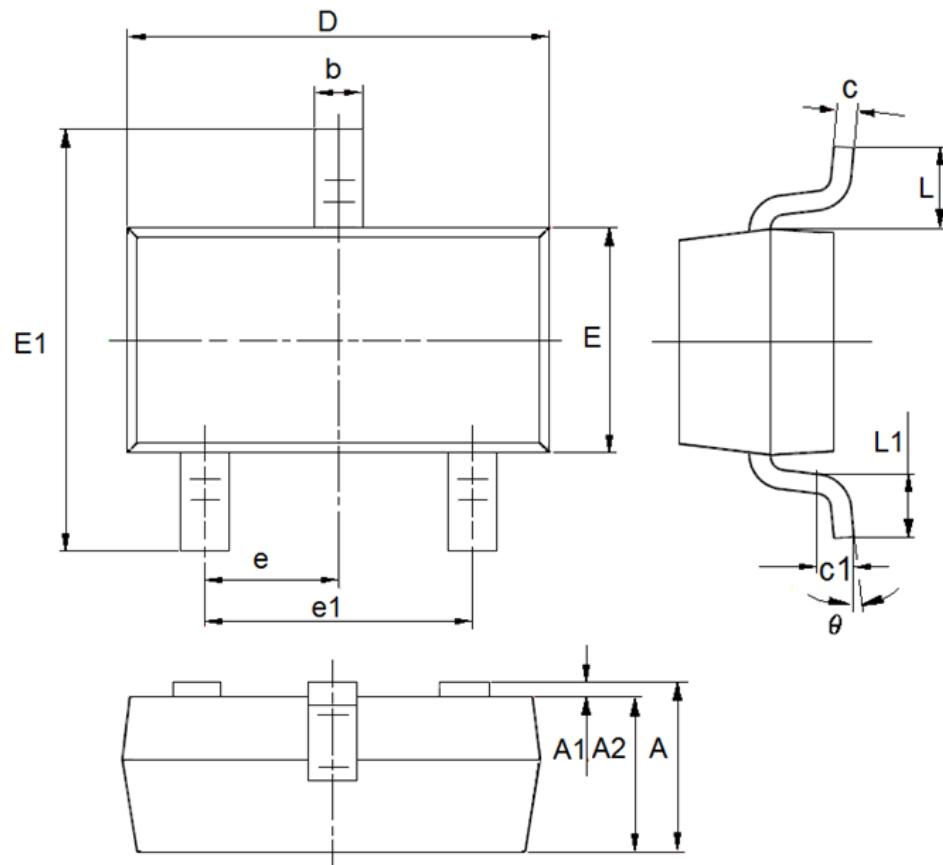
Packaging Information

- SOT23-3



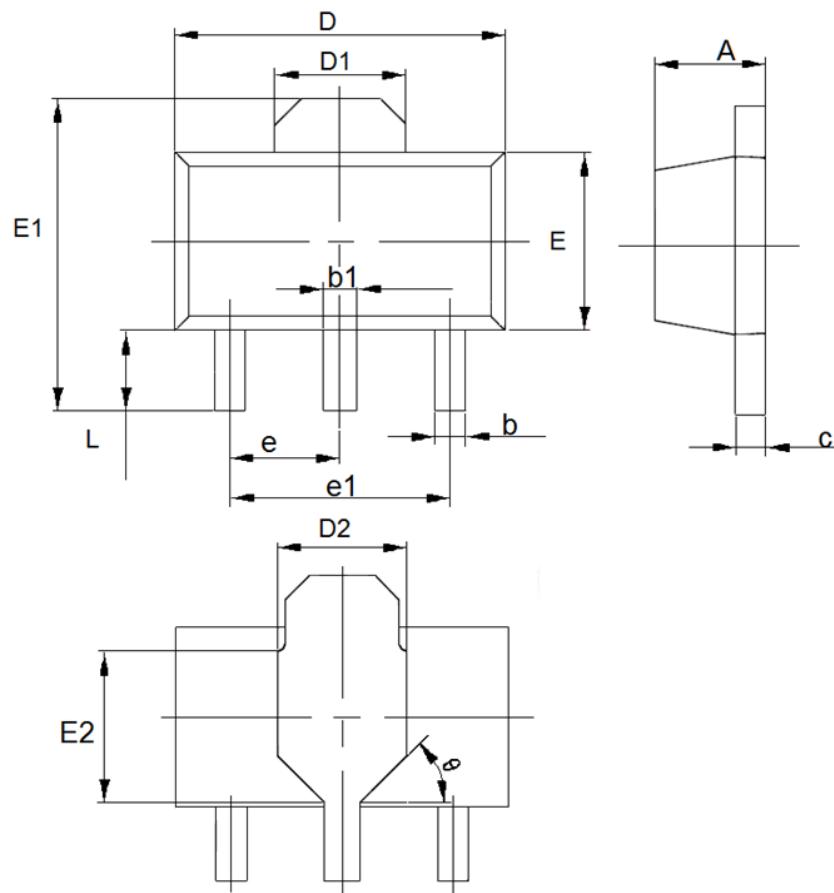
DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	1	1.5	0.0394	0.0591
A1	0	0.15	0	0.0059
A2	0.9	1.3	0.0354	0.0512
A3	0.6	0.7	0.0236	0.0276
b	0.25	0.5	0.0098	0.0197
c	0.1	0.25	0.0039	0.0098
D	2.8	3.1	0.1102	0.122
E	2.6	3.1	0.1023	0.122
E1	1.5	1.8	0.0591	0.0709
e	0.95(TYP)		0.0374(TYP)	
L	0.25	0.6	0.0098	0.0236
L1	0.59(TYP)		0.0232(TYP)	
θ	0	8°	0	8°
c1	0.2(TYP)		0.0079(TYP)	

● SOT23



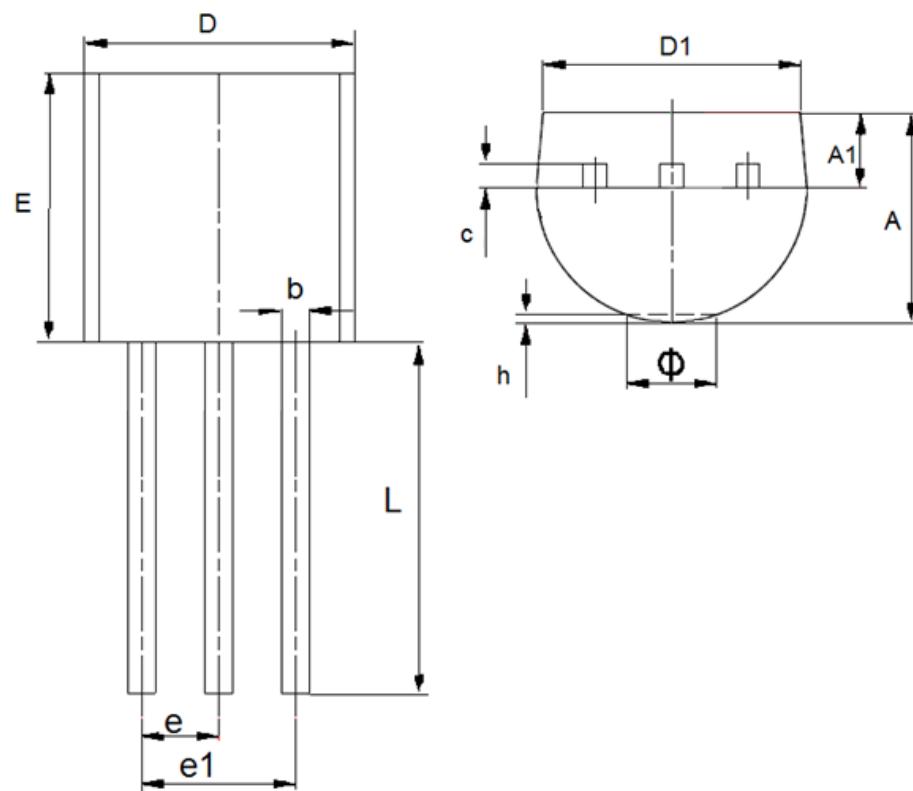
DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	0.9	1.15	0.0354	0.0453
A1	0	0.14	0	0.0055
A2	0.9	1.05	0.0354	0.0413
b	0.28	0.52	0.011	0.0205
c	0.07	0.23	0.0028	0.0091
D	2.8	3	0.1102	0.1181
e1	1.8	2	0.0709	0.0787
E	1.2	1.4	0.0472	0.0551
E1	2.25	2.55	0.0886	0.1004
e	0.95(TYP)		0.0374(TYP)	
L	0.55(TYP)		0.0217(TYP)	
L1	0.25	0.55	0.0098	0.0217
theta	0	8°	0	8°
c1	0.25(TYP)		0.0098(TYP)	

● SOT89-3



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	1.4	1.6	0.0551	0.063
b	0.32	0.52	0.0126	0.0205
b1	0.4	0.58	0.0157	0.0228
c	0.35	0.45	0.0138	0.01772
D	4.4	4.6	0.1732	0.1811
D1	1.55(TYP)		0.061(TYP)	
D2	1.75(TYP)		0.0689(TYP)	
e1	3(TYP)		0.1181(TYP)	
E	2.3	2.6	0.0906	0.1023
E1	3.94	4.4	0.1551	0.1732
E2	1.9(TYP)		0.0748(TYP)	
e	1.5(TYP)		0.0591(TYP)	
L	0.8	1.2	0.0315	0.0472
θ	45°		45°	

● TO92



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	3.3	3.7	0.1299	0.1457
A1	1.1	1.4	0.0433	0.0551
b	0.38	0.55	0.015	0.0217
c	0.36	0.51	0.0142	0.0201
D	4.3	4.7	0.1693	0.185
D1	3.43	—	0.135	—
E	4.3	4.7	0.1693	0.185
e	1.27		0.05	
e1	2.44	2.64	0.0961	0.1039
L	14.1	14.5	0.5551	0.5709
h	0	0.38	0	0.015
Φ	—	1.6	—	0.063

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